



RoHS

FEATURES

- PSI Pressure Ranges
- PCB Mountable
- Digital Output
- Barbed Pressure Ports

APPLICATIONS

- Blocked Filter Detection
- Altitude and Airspeed Measurements
- Medical Instruments
- Fire Suppression System
- Panel Meter
- Air Movement/Environmental Controls
- Pneumatic Controls

MS4525DO

SPECIFICATIONS

- PCB Mounted Digital Output Transducer
- Combination Temperature and Pressure
- I²C or SPI Protocol
- Differential, Gage, Absolute, Compound, & Vacuum
- Temperature Compensated
- 3.3 or 5.0 V_{DC} Supply Voltage
- Low Power Option Available (standby < 1µA)

The MS4525DO is a small, ceramic based, PCB mounted pressure transducer from TE Connectivity. The transducer is built using our proprietary UltraStable[™] process and the latest CMOS sensor conditioning circuitry to create a low cost, high performance digital output pressure (14bit) and temperature (11bit) transducer designed to meet the strictest requirements from OEM customers.

The MS4525DO is fully calibrated and temperature compensated with a total error band (TEB) of less than 1.0% over the compensated pressure range. The sensor operates from single supply of either 3.3 or $5.0V_{DC}$ and requires a single external component for proper operation

The rugged ceramic transducer is available in side port, top port, and manifold mount and can measure absolute, gauge, differential, vacuum or compound pressure from 1 to 150psi. The 1/8" barbed pressure ports mate securely with 3/32" ID tubing.

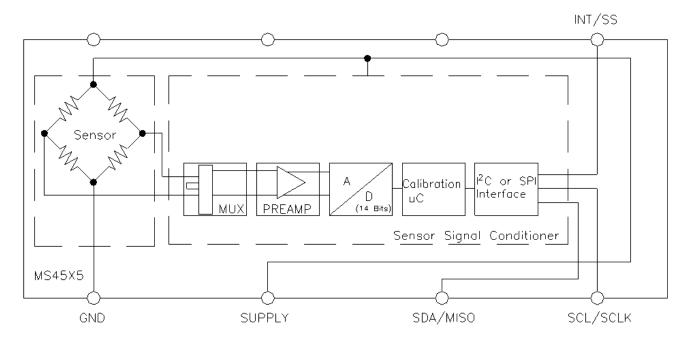


STANDARD RANGES (PSI)

Pressure	Absolute	Gage	Differential	Compound	Vacuum	Option Availability
1		DS, SS, TP, MM	DS, SS, TP, MM			-F, -L, -M
2		DS, SS, TP, MM	DS, SS, TP, MM			-F, -L, -M
5		DS, SS, TP, MM	DS, SS, TP ,MM			-F, -L, -M
15	SS, TP	DS, SS, TP, MM	DS, MM	SS, TP	SS, TP, DS	-F, -L, -M
30	SS, TP	DS, SS, TP, MM	DS, MM	SS, TP		-F, -L, -M
50	SS, TP	DS, SS, TP, MM	DS, MM	SS, TP		-F, -L, -M
100	SS, TP	DS, SS, TP, MM	DS, MM	SS, TP		-F, -L, -M
150	SS, TP	DS, SS, TP, MM	DS, MM	SS, TP		-F, -L, -M

See Package Configurations: DS= Dual Side Port, SS= Single Side Port, TP= Top Port, MM= Manifold Mount Only I²C Protocol is Available on "L" type Pin Styles; Reference Ordering Information for Details Pin Style "L" is only available SS and MM port types.

BLOCK DIAGRAM





ABSOLUTE MAXIMUM RATINGS

Parameter	Conditions	Min	Max	Unit	Notes
Supply Voltage	T _A = 25 °C	2.7	5.5	V	
Output Current	$T_A = 25^{\circ}C$		3	mA	
Storage Temperature		-40	+125	°C	
Humidity	$T_A = 25^{\circ}C$		95	%RH	Non Condensing
Overpressure	T _A = 25 °C, both Ports	Not to	Exceed 300	psi	
Burst Pressure	T _A = 25 °C, Port 1			psi	See Table 1
ESD	Contact Discharge	-2	+2	kV	
MSL		Moisture Sensit	ivity Level 1		
Solder Temperature		250°C	C, 5 sec max.		

TABLE 1- BURST PRESSURE BY RANGE AND PACKAGE STYLE

Range	DS	SS, TP, MM	Unit
001	20	20	psi
002	20	20	psi
005	15	20	psi
015	45	90	psi
030	90	200	psi
050	150	300	psi
100	300	300	psi
150	300	300	psi

ENVIRONMENTAL SPECIFICATIONS

Parameter	Conditions
Mechanical Shock	Mil Spec 202F, Method 213B, Condition C, 3 Drops
Mechanical Vibration	Mil Spec 202F, Method 214A, Condition 1E, 1Hr Each Axis
Thermal Shock	100 Cycles over Storage Temperature, 30 minute dwell
Life	1 Million FS Cycles
MTTF	>10Yrs, 70 °C, 1.188 Million Pressure Cycles, 120%FS Pressure



PERFORMANCE SPECIFICATIONS

Supply Voltage¹: 5.0V or 3.3 V_{DC}

Reference Temperature: 25°C (unless otherwise specified)

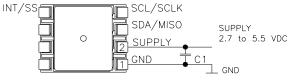
PARAMETERS	MIN	ТҮР	MAX	UNITS	NOTES	
Accuracy	-0.25		0.25	% SPAN	2	
Total Error Band	-1		1	% SPAN	3,7	
Burst pressure		SEE T	ABLE 1			
Common mode pressure		NOT TO EXC	CEED 300 PSI			
Load Resistance (R _L)	10			kΩ		
Long term stability (offset & span)		±0.5		% SPAN		
Compensated Temperature	-10		85	٥°C		
Operating Temperature	-25		105	С°		
Weight	1.43		2.02	grams		
Update time		0.5		ms	6	
Start time to data ready			8.4	ms	6	
Solder temperature		250°C MA	AX 5 SEC.			
Media	Non-Corrosive Dry Gases Compatible with Ceramic, Silicon, Borosilicate Glass, RTV, Gold, Aluminum and Epoxy, See "Wetted Material by Port Designation" chart					

RTV, Gold, Aluminum and Epoxy. See "Wetted Material by Port Designation" charl below.

Notes

- 1. Proper operation requires an external capacitor placed as shown in Connection Diagram. Output is not ratiometric to supply voltage.
- 2. The maximum deviation from a best fit straight line (BFSL) fitted to the output measured over the pressure range at 25C. Includes all errors due to pressure non linearity, hysteresis, and non repeatability.
- Total pressure error band includes all accuracy errors, thermal errors over the compensated temperature range and span and offset calibration tolerances. For ideal sensor output with respect to input pressure and temperature, reference Transfer Function charts below. TEB values are valid only at the calibrated supply voltage.
- 4. The deviation from a best fit straight line (BFSL) fitted to the output measured over the compensated temperature range.
- For errors beyond the compensated temperature range, see Extended Temperature Multiplier chart below.
- Start time to data ready is the time to get valid data after POR (power on reset). The time to get subsequent valid data is then specified by the update time specification.
- 7. This product can be configured for custom OEM requirements, contact factory for lower power consumption or higher accuracy.

CONNECTION DIAGRAM



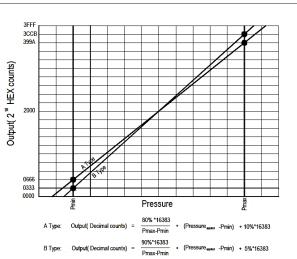
Notes

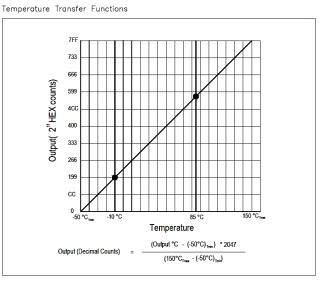
1. Place 100nF capacitor between Supply and GND to within 2 cm of sensor.



PRESSURE AND TEMPERATURE TRANSFER FUNCTION







Sensor Output at Significant Percentages

% of Count	Output Type A (psi)	Output Type B (psi)	Digital Counts (decimal)	Digital Counts (hex)
0	P _{MIN} -(P _{MAX} -P _{MIN})*10/80	P _{MIN} -(P _{MAX} -P _{MIN})*5/90	0	0X0000
5		P _{MIN}	819	0X0333
10	P _{MIN}		1638	0X0666
50			8192	0X2000
90	P _{MAX}		14746	0X399A
95		P _{MAX}	15563	0X3CCB
100	P _{MAX} +(P _{MAX} -P _{MIN})*10/80	P _{MAX} +(P _{MAX} -P _{MIN})*5/90	16383	0X3FFF

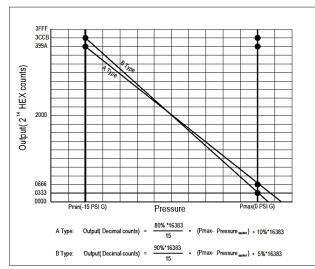
Temperature Output vs Counts

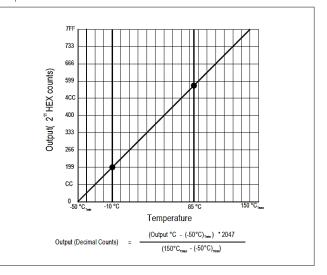
OUTPUT (°C)	Digital Count (decimal)	Digital Counts (hex)
-50	0	0X0000
0	511	0X01FF
10	614	0X0266
25	767	0X02FF
50	1023	0X03FF
85	1381	0X0565
150	2047	0X07FF



Vacuum Series Pressure Transfer Functions

Temperature Transfer Functions





Sensor Output at Significant Percentages

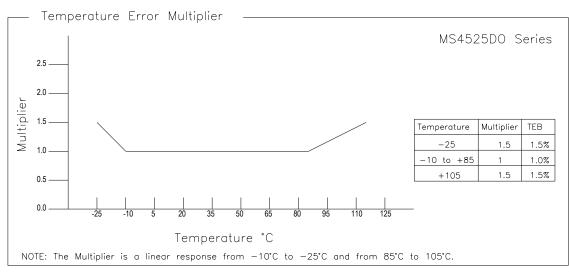
% of Count	Output Type A (psi)	Output Type B (psi)	Digital Counts (decimal)	Digital Counts (hex)
0	1.6875	0.833	0	0X0000
5		0	819	0X0333
10	0		1638	0X0666
50			8192	0X2000
90	-15		14746	0X399A
95		-15	15563	0X3CCB
100			16383	0X3FFF

Temperature Output vs Counts

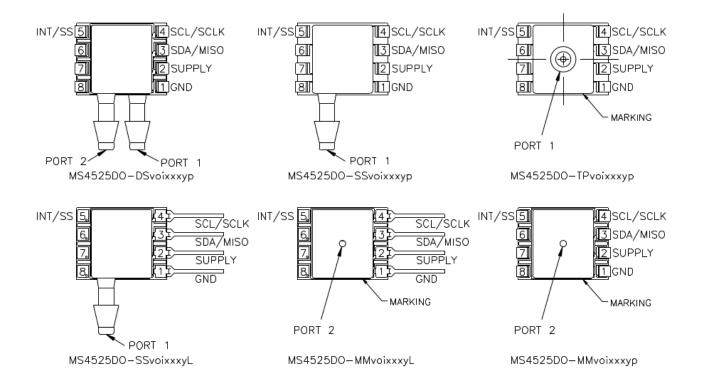
OUTPUT (°C)	Digital Count (decimal)	Digital Counts (hex)
-50	0	0X0000
0	511	0X01FF
10	614	0X0266
25	767	0X02FF
50	1023	0X03FF
85	1381	0X0565
150	2047	0X07FF



EXTENDED TEMPERATURE MULTIPLIER CHART



PACKAGE, PINOUT & PRESSURE TYPE CONFIGURATION





Pin Name	•	Pin	Function	
GND		1	Ground	
SUPPLY		2	Positive Supply	y Voltage
SDA	MISO	3	I2C Data	SPI Data
SCL	SCLK	4	I2C Clock	SPI Clock
INT	SS	5	I2C Interrupt	SPI Chip Select
		6-8	No Connection	

INT is not available for Pin Style "L" models

Pressure Type	Pmin	P _{max}	Description
Absolute	0psiA	+P _{range}	Output is proportional to the difference between 0psiA (P_{min}) and pressure applied to Port 1.
Differential/ Bidirectional	-P _{range}	+P _{range}	Output is proportional to the difference between Port 1 and Port 2. Output swings positive when Port 1> Port 2. Output is 50% of total counts when Port 1=Port 2.
Gauge	0psiG	+Prange	Output is proportional to the difference between 0psiG (P _{min}) and Port 1. Output swings positive when Port 1> Port 2.
Vacuum	-15psiG	+0psiG	Output is inversely proportional to the difference between -15psiG pressure (P_{min}) and pressure applied to Port 1.
Compound	-15psiG	+Prange	Output is proportional to the difference between -15psiG pressure (P_{min}) and pressure applied to Port 1.

 $^{\ast}\mathsf{P}_{\text{range}}$ is equal to the maximum full scale pressure specified in the ordering information.

Standard ranges (psi) by port style

WETTED MATERIAL BY PORT DESIGNATION

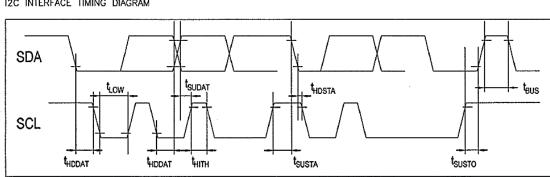
				Mate	rial			
Style	Port	Ceramic	Silico	Borosilicate Glass	RTV	Gold	Aluminum	Ероху
			n					
	Port 1	Х	Х	Х	Х			Х
DS, MM	Port 2	Х	Х	Х	Х	Х	Х	Х
SS, TP, SM 'X' indicates Wetted M	Port 1 laterial	Х	Х	Х	Х	Х	Х	Х



I²C INTERFACE

I2C INTERFACE PARAMETERS					
PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS
SCLK CLOCK FREQUENCY	FSCL	100		400	KHz
START CONDITION HOLD TIME RELATIVE TO SCL EDGE	tHDSTA	0.1			uS
MINIMUM SCL CLOCK LOW WIDTH @1	tLOW	0.6			uS
MINIMUM SCL CLOCK HIGH WIDTH @1	thigh	0.6			uS
START CONDITION SETUP TIME RELATIVE TO SCL EDGE	tSUSTA	0.1			uS
DATA HOLD TIME ON SDA RELATIVE TO SCL EDGE	tHDDAT	0			uS
DATA SETUP TIME ON SDA RELATIVE TO SCL EDGE	tSUDAT	0.1			uS
STOP CONDITION SETUP TIME ON SCL	tSUSTO	0.1			uS
BUS FREE TIME BETWEEN STOP AND START CONDITION	tBUS	2			uS

@1 COMBINED LOW AND HIGH WIDTHS MUST EQUAL OR EXCEED MINIMUM SCL PERIOD.



12C INTERFACE TIMING DIAGRAM

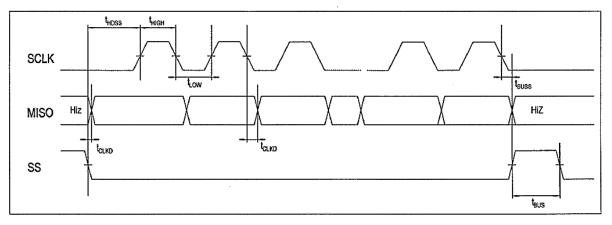


SPI INTERFACE

SPI INTERFACE PARAMETERS							
PARAMETERS	SYMBOL	MIN	TYP	MAX	UNITS		
SCLK CLOCK FREQUENCY	FSCL	50		800	KHz		
SS DROP TO FIRST CLOCK EDGE	tHDSS	2.5			u\$		
MINIMUM SCL CLOCK LOW WIDTH @1	tLOW	0.6			uS		
MINIMUM SCL CLOCK HIGH WIDTH @1	tHIGH	0.6			uS		
CLOCK EDGE TO DATA TRANSITION	tCLKD	0		0.1	uS		
RISE OF SS RELATIVE TO LAST CLOCK EDGE	tSUSS	0.1			uS		
BUS FREE TIME BETWEEN RISE AND FALL OF SS	tBUS	2			υS		

@1 COMBINED LOW AND HIGH WIDTHS MUST EQUAL OR EXCEED MINIMUM SCLK PERIOD.

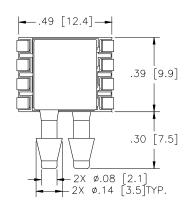
SPI INTERFACE TIMING DIAGRAM

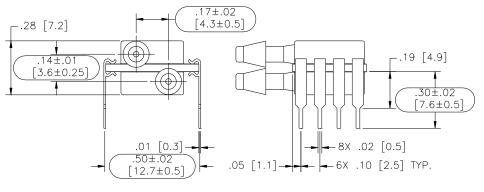




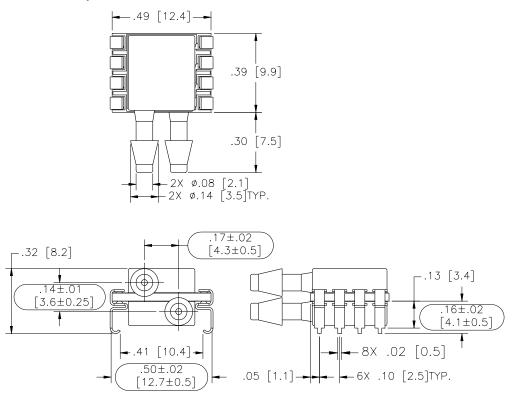
DIMENSIONS

Model: MS4525DO-DSvoixxxyP



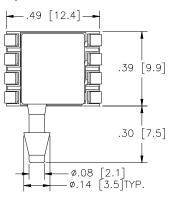


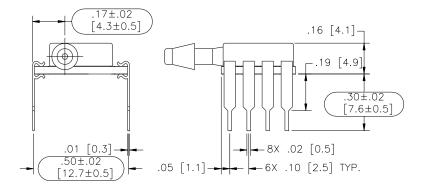
Model: MS4525DO-DSvoixxxyS



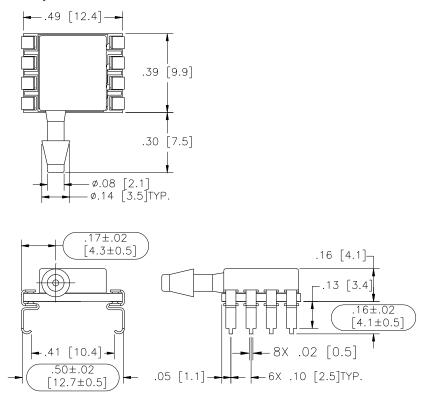


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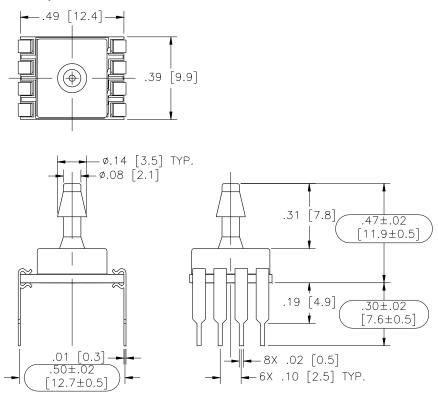


Model: MS4525DO-SSvoixxxyS

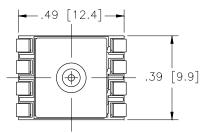


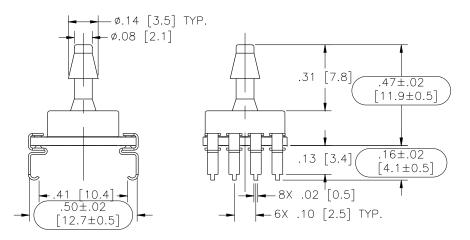


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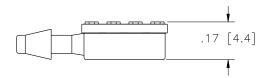
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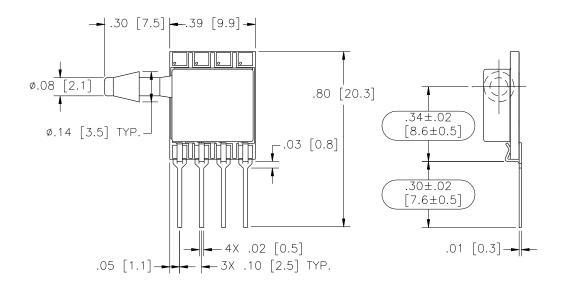




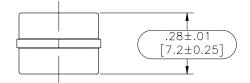


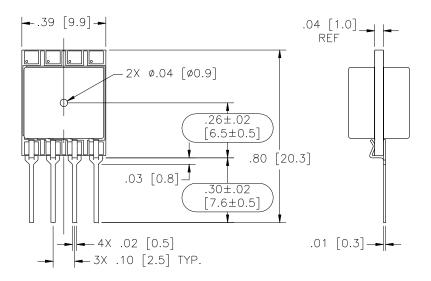
Model: MS4525DO-SSvoixxxyL





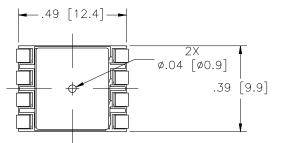
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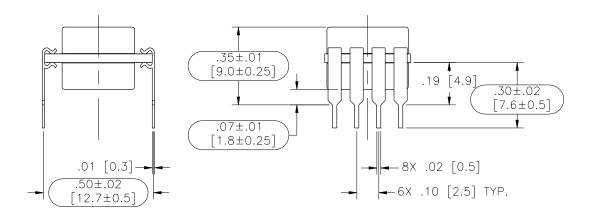




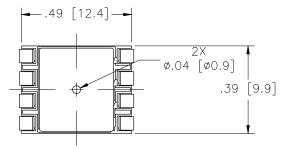


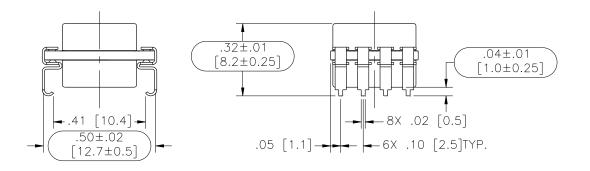
Model: MS4525DO-MMvoixxxyP





Model: MS4525DO-MMvoixxxyS







APPLICATION NOTES

Measurement Specialties offers a comprehensive selection of product support documentation.

MS45xx Series Application Note

- Bypass Capacitor Selection
- Pressure Hose Recommendations
- PCB Layout Recommendations

Interfacing to MEAS Digital Pressure Modules

- I²C or SPI Protocol Description
- Data Fetch, Measurement Request Commands
- Timing Diagrams

Configuration, POR and Power Consumption

- Standard and Low Power Configuration
- Power On Reset (POR)
- Current Consumption by Sampling Frequency

AVAILABLE OPTIONS

Gel Coat (-F Option)

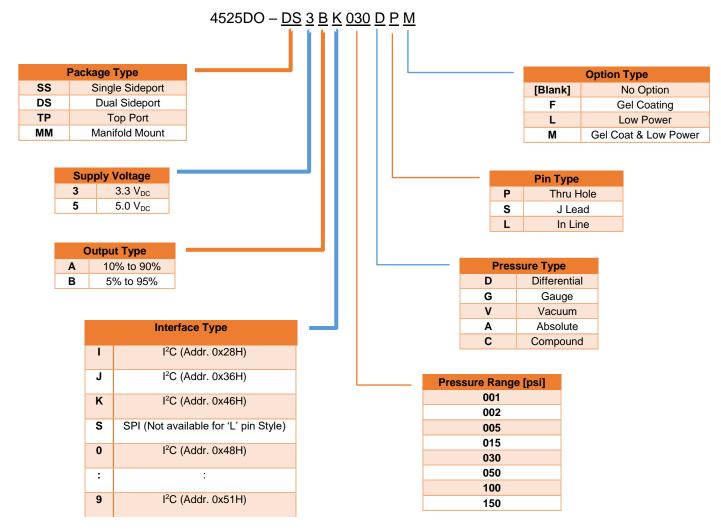
The MS4525DO is designed for non-ionic and clean dry air applications. Select this option for added protection in high humidity or slightly corrosive environments with the application of a silicone gel elastomer to sensor and ASIC. For questions concerning media compatibility, contact the factory.

Low Power (-L Option)

Select this option for battery powered or handheld device applications. In this configuration, the sensor and calibration microcontroller are powered down, drawing a current of ~ 0.6uA (V_s =5.0 V_{DC}). When the master sends a **Read MR** (measurement request) command (I²C or SPI); the sensor is "awaken" and begins the measurement cycle; data is then placed onto the output registers. The sensor and calibration microcontroller are powered down again, awaiting the **Read DF** (data fetch) command from the master.



ORDERING INFORMATION



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TE.com/sensorsolutions

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